



Material Content Data Sheet				RoHS		Halogen-Free		
Sales Product Name	TLE9832QX			Issued		21. September 2015		
MA#	MA001408908							
Package	PG-VQFN-48-29			Weight*		130.25 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	4.983	3.83	3.83	38258	38258
leadframe	inorganic material	phosphorus	7723-14-0	0.018	0.01		138	
	non noble metal	zinc	7440-66-6	0.072	0.06		550	
	non noble metal	iron	7439-89-6	1.433	1.10		11003	
	non noble metal	copper	7440-50-8	58.193	44.67	45.84	446775	458466
wire	noble metal	gold	7440-57-5	0.782	0.60	0.60	6007	6007
encapsulation	organic material	carbon black	1333-86-4	0.181	0.14		1388	
	plastics	epoxy resin	=	7.656	5.88		58778	
	inorganic material	silicondioxide	60676-86-0	52.446	40.26	46.28	402650	462816
leadfinish	non noble metal	tin	7440-31-5	2.629	2.02	2.02	20183	20183
plating	noble metal	silver	7440-22-4	0.614	0.47	0.47	4713	4713
glue	plastics	epoxy resin	-	0.286	0.22		2198	
	noble metal	silver	7440-22-4	0.958	0.74	0.96	7359	9557
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

- 1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
- 2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
- 3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2011/65/EU (RoHS) and does not use any exemption.

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